

## ► Features

**HCMOS Output**

**5.0, 3.3V, 2.5V, 1.8 Operation**

**Surface Mount Package**

**Tri-state**

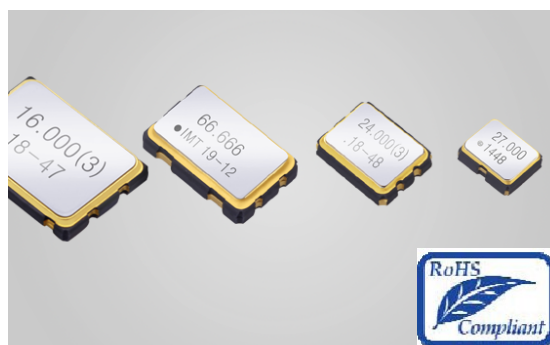
**AT-Cut Crystal**

**Fund, 3<sup>rd</sup> Oscillation Mode.**

**0to70 °C, -40to85 °C OPT Range.**

**Low RMS Phase Jitter**

**RoHS Compliant (pb-Free)**



**Dimensions(mm)**      **5.0 x 7.0 x 1.8max**

**5.0 x 3.2 x 1.3max**

**3.2 x 2.5 x 1.0max**

**2.5 x 2.0 x 1.0max**

## Absolute Maximum Ratings *(For user guidelines only)*

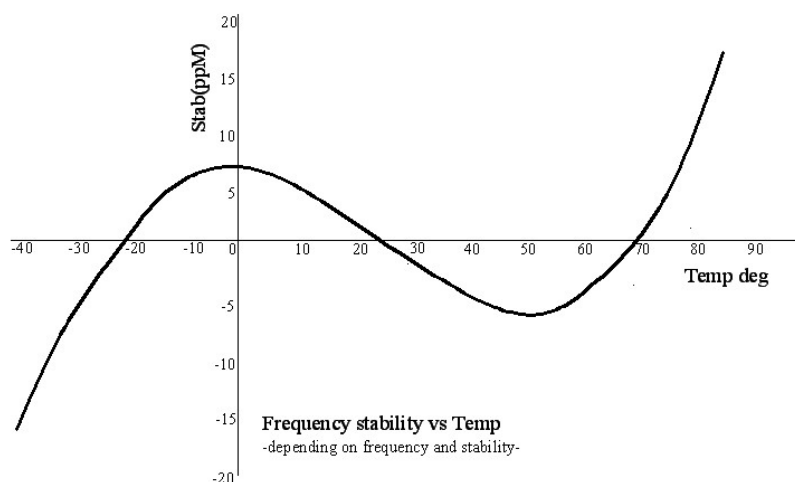
Parameter	Maximum Value	Units	Condition
Supply voltage(Vdd)	7	Vdc	Depending on Vdd
Operating Temperature	-40 to 85	°C	
Storage Temperature	-50 to 120	°C	Max
ESD Sensitivity	1	kV	HBM

## Supply Voltage & Consumption.

Parameter	Value	Units	Condition
Supply Voltage(Vdd)	1.8V ±5%	DC	
Current Consumption	20	mA Max	HCMOS
Supply Voltage(Vdd)	2.5V ±5%	DC	
Current Consumption	20	mA Max	HCMOS
Supply Voltage(Vdd)	3.3V ±5%		
Current Consumption	30	mA Max	HCMOS
Supply Voltage(Vdd)	5.0V ±5%	DC	
Current Consumption	40	mA Max	HCMOS
Start up Time(Ts)	5	mS	Max

## Frequency Stabilities<sup>1</sup>

Parameter	Typical Value	Units	Condition
Vs. Temperature	±10	ppM max	0to70°C
	±25	ppM max	-40to85°C
Vs. Calibration @25°C	±10	ppm max	±2°C
Vs. Vdd	±1	ppm max	±5% of Vdd
Vs. Load	±0.3	ppM max	±5% change
Aging 1 <sup>st</sup> year	±2	ppM max	
Overall Stability (includes temperature And initial accuracy)	±15	ppM max	0to50°C
	±25	ppM max	-20to70°C
	±50	ppM max	-40to85°C

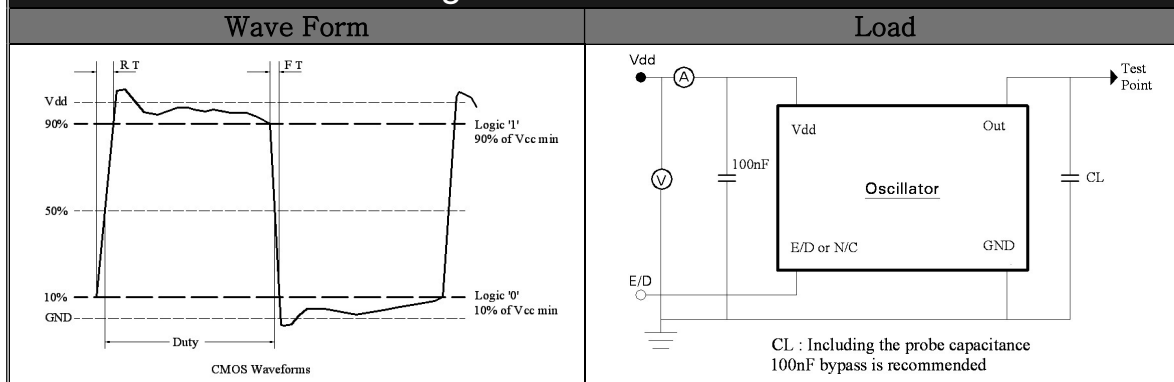


## RF output<sup>1</sup>

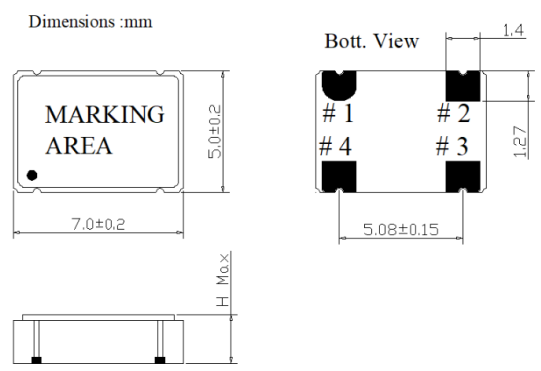
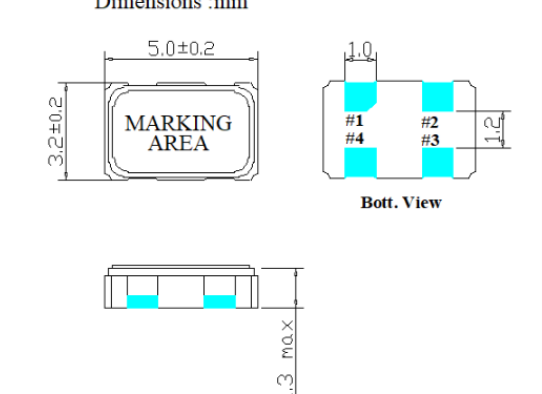
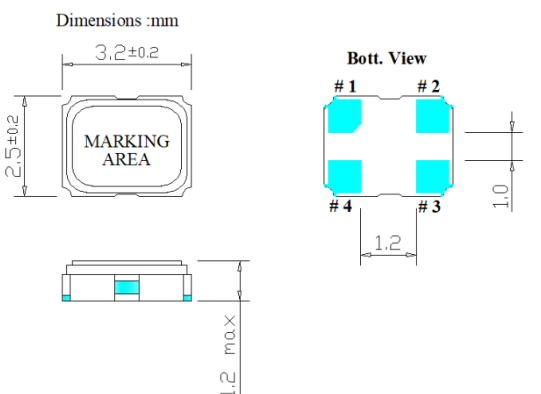
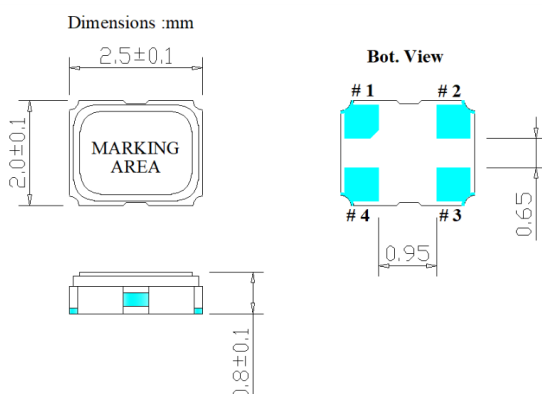
	Parameter	Typical Value	Units	Condition
HCMOS	Output Load	15	pF	
	Rise(Tr),Fall(Tf) time	10	nS max	10to 90%
	Output Level High	10%Vdd	V min	VOH
	Output Level Low	90%Vdd	V max	VOL
	Symmetry	50±10	%	50% of Vdd

<sup>1</sup> About Test Condition Refer to Wave Form

## Wave Form & Load Configuration



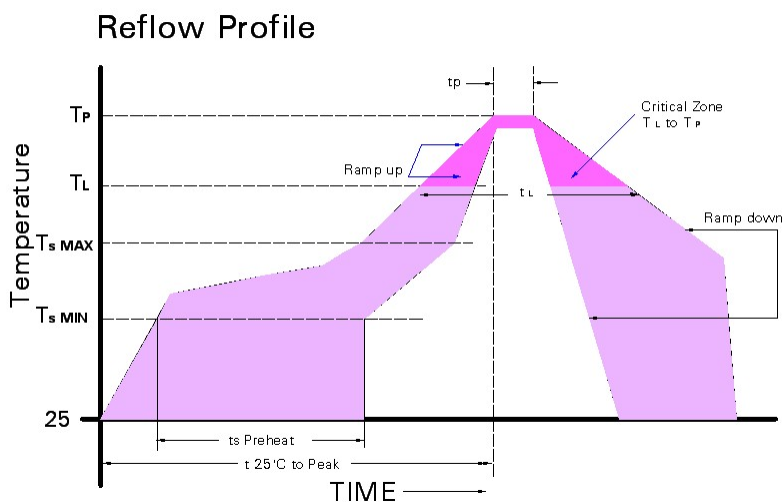
## Mechanical Dimensions

D7 Ceramic 5mm x 7mm for Cmos		D5 Ceramic 5mm x 3.2mm for Cmos	
<p>Dimensions :mm</p> 		<p>Dimensions :mm</p> 	
Code:D7	5.0 x 7.0 x 1.8max	Code : D5	3.2 x .5.0 x 1.3max
D3 Ceramic 2.5mm x 3.2mm for Cmos		D2 Ceramic 2.0mm x 2.5mm for Cmos	
<p>Dimensions :mm</p> 		<p>Dimensions :mm</p> 	
Code:D3	2.5 x 3.2 x 1.2max	Code : D2	2.0 x 2.5 x 1.0max
Pin1: E/D or N/C, Pin2: Gnd, Pin3: Output, Pin4 : Vdd			

## Marking

32.000Mhz	-Frequency
iXHD73-ECO	-Part No.
● IMT wwyy	-week/year

## Recommended Reflow Profile



Note: Temperatures refer to body of device.

Oscillators must be on the top side of the PCB during the reflow process.

Ts max to TL (Ramp-up rate)	3°C/second max
Preheat -Temperature Min(Ts min)	150°C
-Temperature Typical(Ts TYP)	175°C
-Temperature Max(Ts Max)	200°C
-Time(ts)	60-180 Seconds
Ramp-up Rate(TL to TP)	3°C/Second max
Time Maintained Above-Temperature(TL)	217°C
-Time(TL)	60-150 Seconds
Peak Temperature(Tp)	250°C Max for 10 seconds Max
Target Peak Temperature(Tp Target)	240°C
Time within 5°C of actual peak(tp)	20-40 seconds
Ramp-down Rate	6°C/second max
Time 25°C to peak Temperature	8 minutes max

## Part Numbering Guide & Code ...iXHD73-EC0-32M000-T

iXHD7 (HCMOS)

Logic	Supply voltage	Operating Temperature	Stability	Frequency	Packaging Option
<b>iXHD7</b>	<b>3</b>	<b>E</b>	<b>C0</b>	<b>32M000</b>	<b>T</b>
P: LVPECL H: HCMOS L: LVDS	5:5.0V 3:3.3V 2:2.5V 1:1.8V	A: 0...50°C B: 0...70°C E:-40...85°C	A5: ±15ppM B5: ±25ppM E0: ±50ppM	32.000Mhz	T: Tape & Reel B: Bulk
Above example, Crystal Oscillator, HCMOS output, SMD package, 3.3V, -40to 85°C Temperature range, Overall ±30ppM, at 32.000Mhz.					